# Development of PPD Sensitive to Deep UV Scintillation Photons of Liquid Xenon

W. Ootani, X. Bai, T. Chiba, Y. Fujii, T. Iwamoto, D. Kaneko, T. Mori, H. Natori, R. Sawada and Y. Uchiyama *ICEPP, University of Tokyo* 

S. Mihara and H. Nishiguchi KEK, High Energy Accelerator Research Organization

A. Stoykov

Paul Scherrer Institut

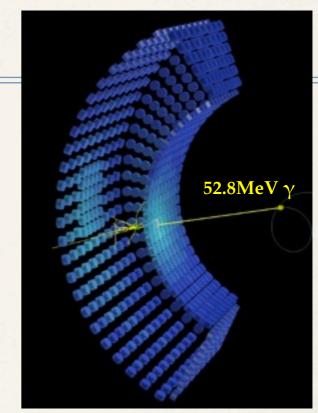
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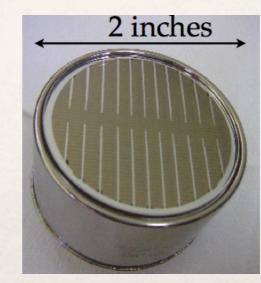


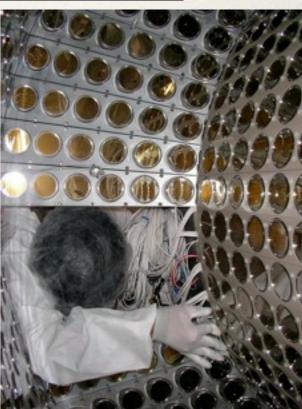
# MEG LXe Scintillation Detector

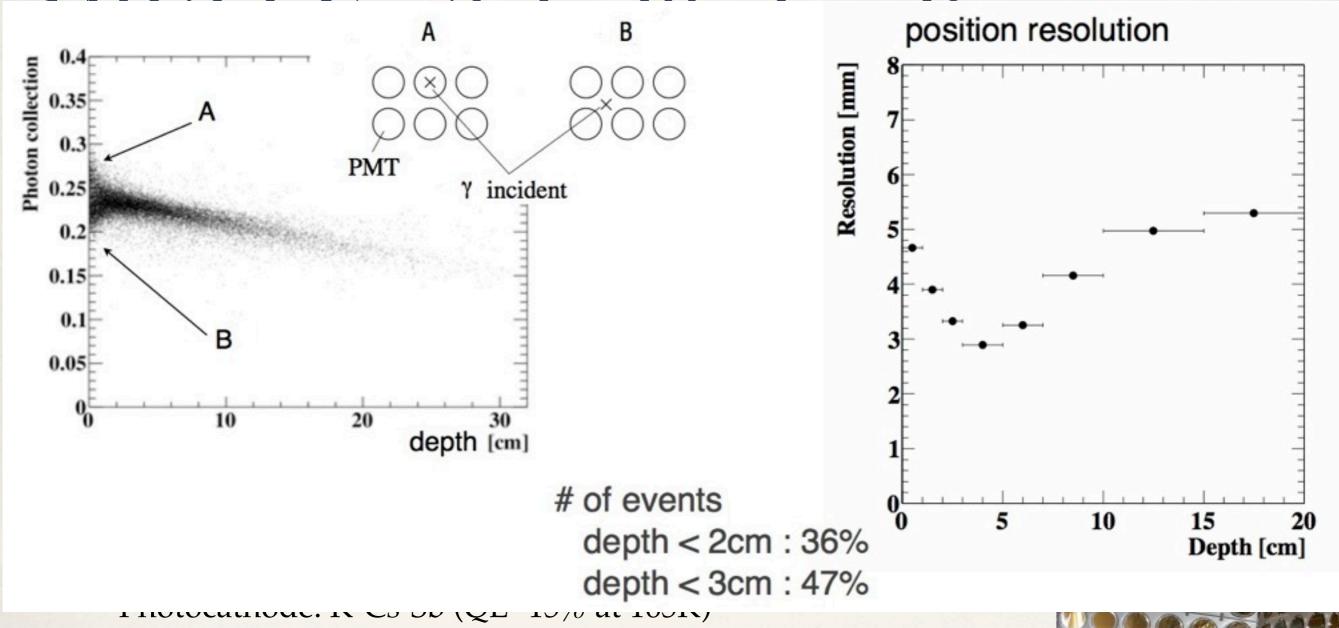
- \* MEG experiment searching for LFV decay,  $\mu \rightarrow e \gamma$ , employs 900 $\ell$ -LXe scintillation detector to measure 52.8MeV- $\gamma$  from  $\mu \rightarrow e \gamma$ .
- \* Scintillation light (VUV  $\lambda$ =175±5nm) collected by 846 UV-sensitive phototubes immersed in LXe
  - Hamamatsu R9869
  - Operational in LXe (T=165K, P<3atm)</li>
  - Synthetic quartz window
  - Photocathode: K-Cs-Sb (QE~15% at 165K)
- \* Limited resolutions for shallow events due to no-uniform PMT coverage









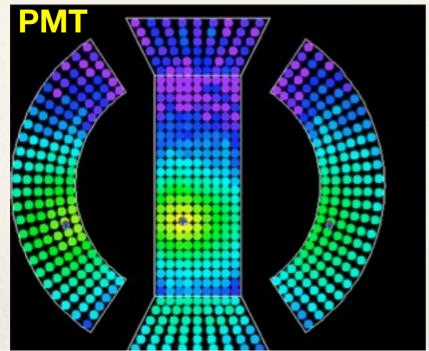


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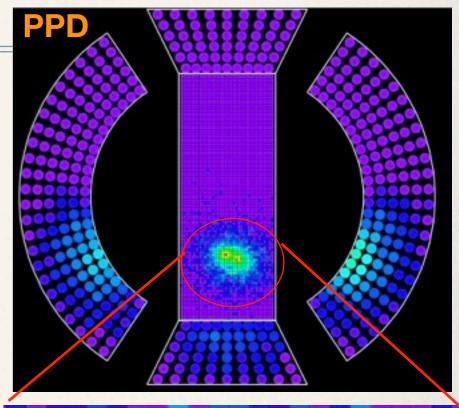


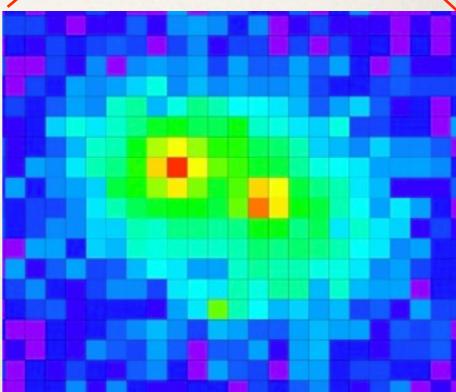
# Possible Upgrade of LXe Detector

- Better imaging with smaller photo sensors
  - \* Replace PMTs (2" $\phi$ ) with small photosensors (~10×10mm²) on  $\gamma$  entrance face
  - \* Position/energy resolutions could greatly improve (factor two for shallow events).
  - Detection efficiency could improve by 9%.
- \* PPD is a good candidate.







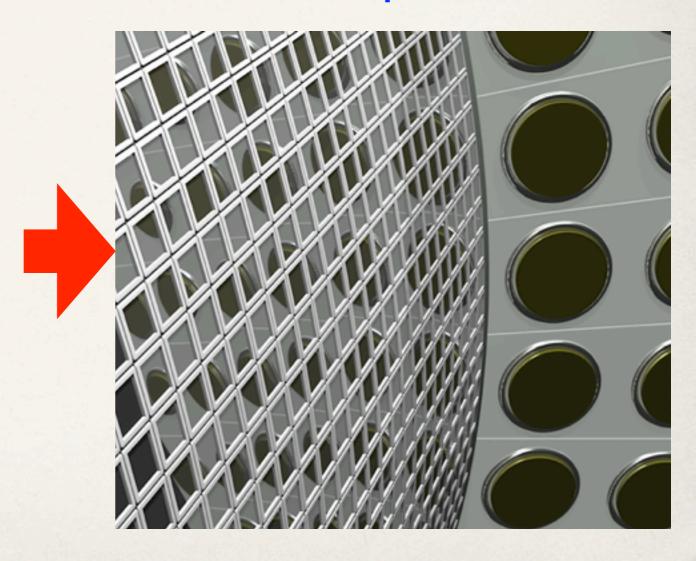


## How It Would Look Like

#### 216 PMTs on γ entrance face



#### ~4000 PPDs on y entrance face



# Possible Advantages of PPD for MEG LXe Detector

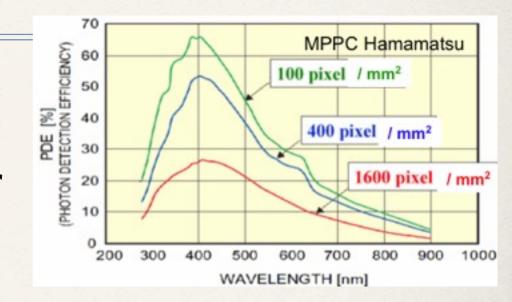
- \* Scintillation readout with finer granularity and higher uniformity.
- \* Reduction of material in  $\gamma$  entrance face. (PPD is much thinner than PMT.)
- Best performance at low temperature (LXe 165K)
- Operational in magnetic field
- Easier calibration using single photoelectron signals
- Low bias voltage (~1000V for PMT ↔ <100V for MPPC)</p>
- Low power consumption (crucial for operation at low temperature)

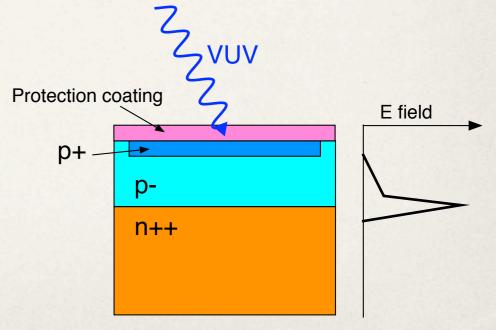
### Possible Issues

- Photon detection efficiency (PDE) for VUV light
- Dark count
- Optical crosstalk
- After-pulsing
- Sensor size
- Dynamic range
- Reflection on sensor surface
- Radiation hardness

### PDE for VUV

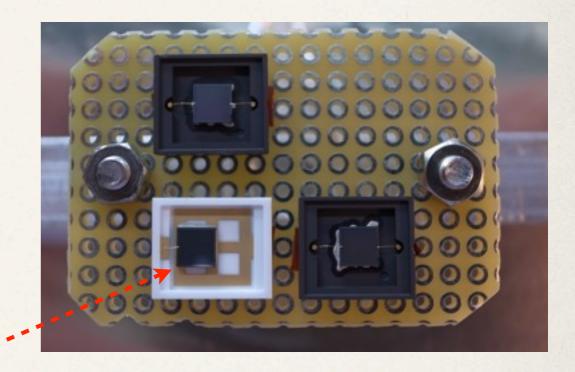
- PDE for VUV is nearly zero for commercial device.
- Low transmission for VUV to sensitive layer due to
  - Protection coating (epoxy resin/silicon rubber)
  - Insensitive layer (p+ contact layer with ~zero field)
    - Absorption length in Si for VUV photon: ~5nm
  - High reflectivity for VUV on Si surface
- Possible solution
  - Remove protection coating
  - Thinner p+ contact layer
  - Optimize reflection/refractive index on sensor surface





# Development of UV-Enhanced MPPC

- UV-enhanced MPPC is under development in collaboration with Hamamatsu.
  - Remove protection coating
  - Optimize MPPC parameters
    - Thinner p<sup>+</sup> contact layer
    - Anti-reflection coating
    - Refractive index of surface material
    - Quench resistor
    - Pixel size
    - \*
  - Currently sensor size: 3×3mm²



# Prototypes of UV-enhanced MPPC

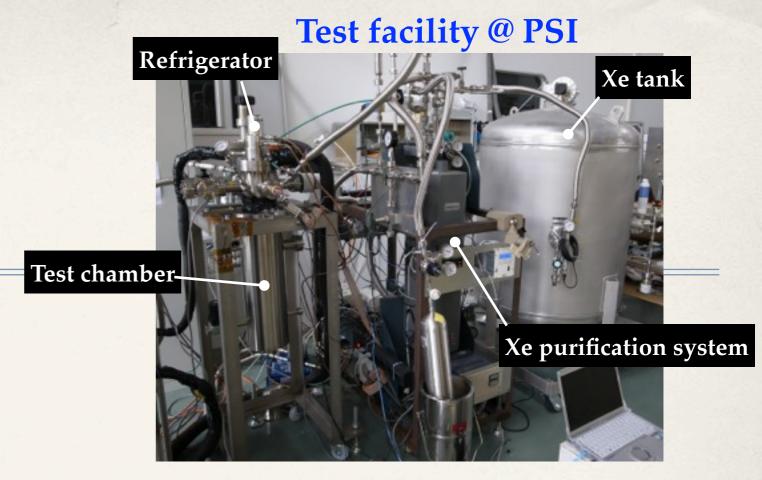
- Prototypes of UV-enhanced MPPC of various types are being tested.
- \* Sensor size: 3×3mm², pixel pitch: 50μm

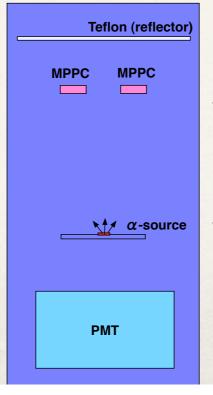
Туре	p+ contact layer	Reflection/refractive index
A	thinner	Anti-reflection
В	thinner	Anti-reflection
C	thinner	Anti-reflection
D	thinner	Anti-reflection
E	thinner	Anti-reflection
F	thinner	Anti-reflection
G	normal	Refractive index
H	normal	Refractive index

Sorry, but we can't show details of the parameters. (we don't know either!)

# Test Setup

- Test facility at Paul Scherrer Institute (PSI).
  - 2ℓ-LXe in small cryostat
  - \*  $\alpha$  source for absolute PDE measurement ( $\alpha$  = point-like light source)
  - UV-sensitive PMT for triggering on alpha
  - LED for calibration
  - Mounted inside cylinder with VUV-"black" coating to suppress reflection
- Average number of photons from alpha event on 3×3mm<sup>2</sup> active area of MPPC ~200-900

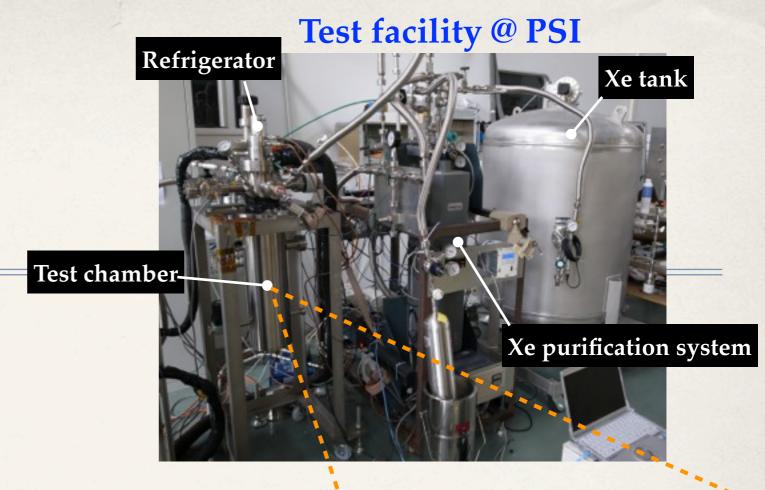


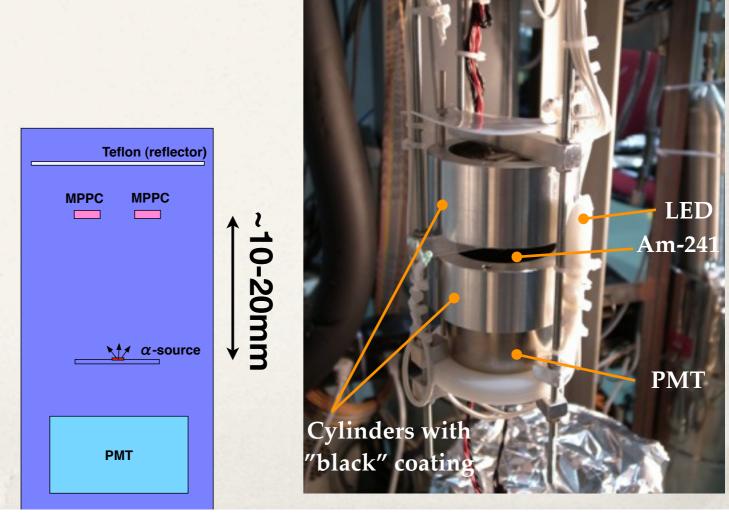




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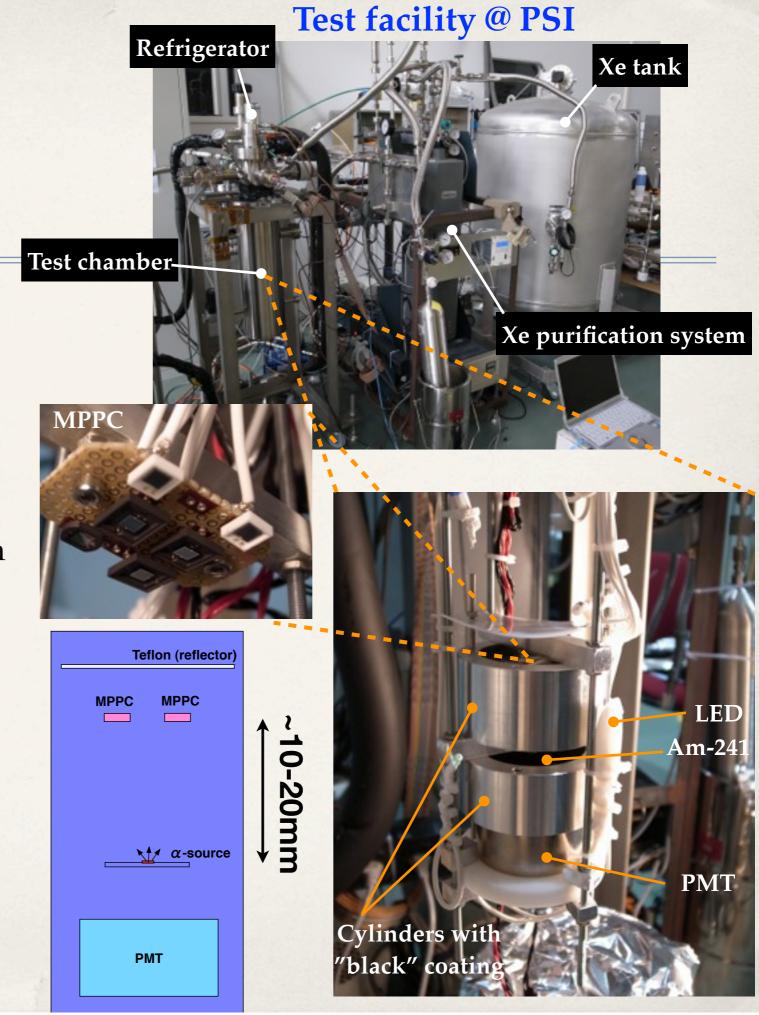
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# Test Setup

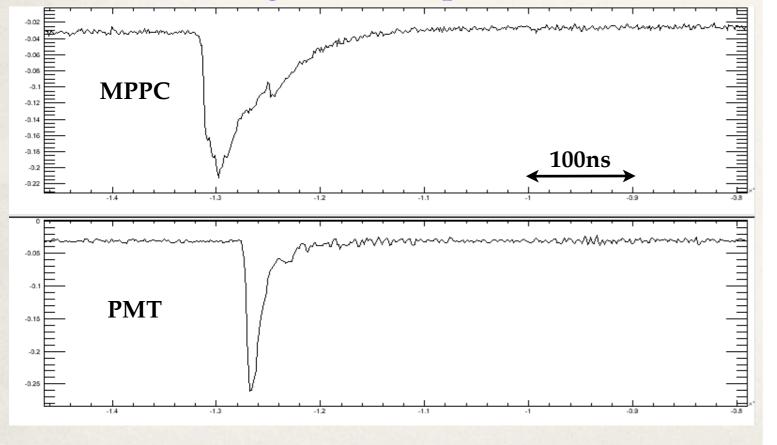
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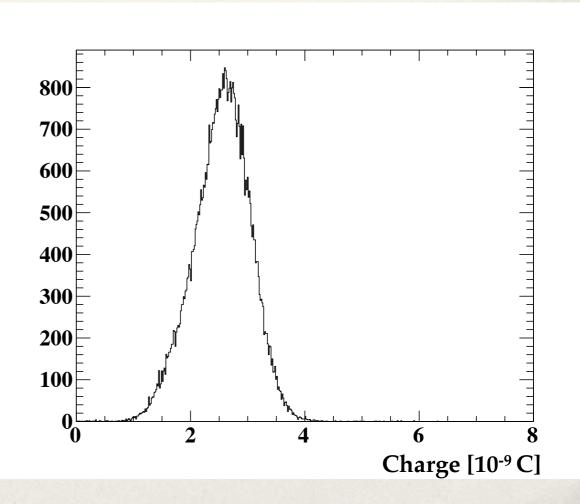
# MPPC Signal from LXe Scintillation

\* We succeeded to detect LXe scintillation from alpha event with prototypes of UV-enhanced MPPC.



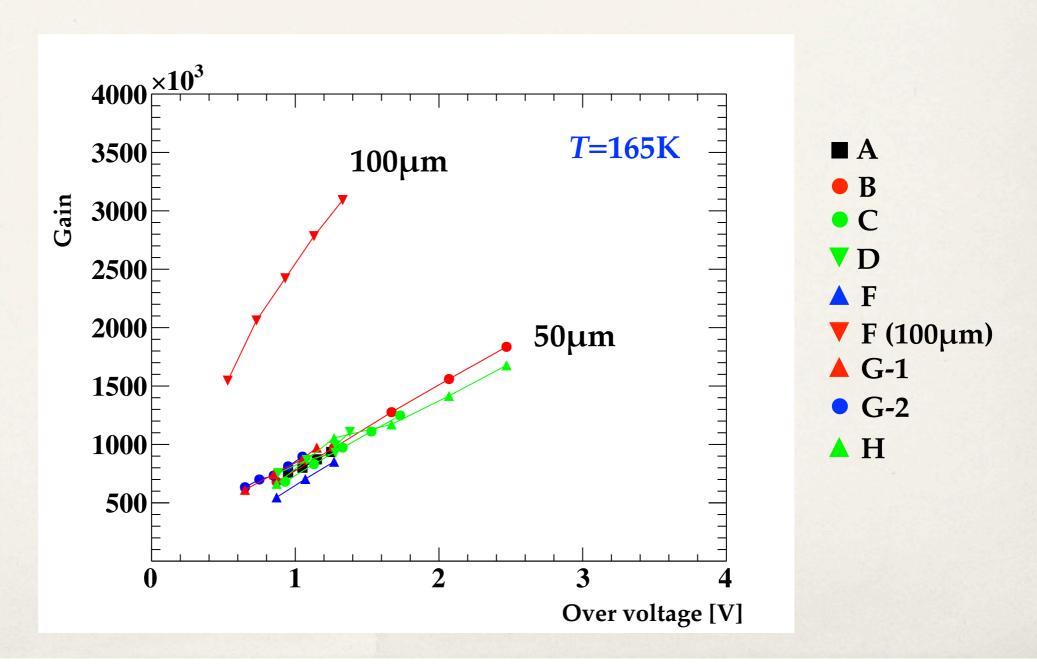


#### Charge spectrum for alpha events



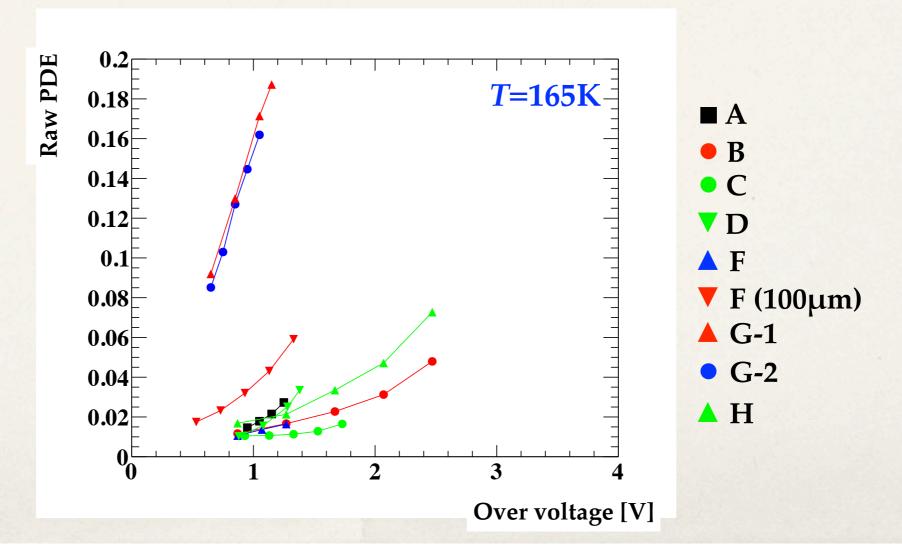
### Gain

\* All samples with 50μm pixel pitch show similar gain ~10<sup>6</sup>.



## PDE

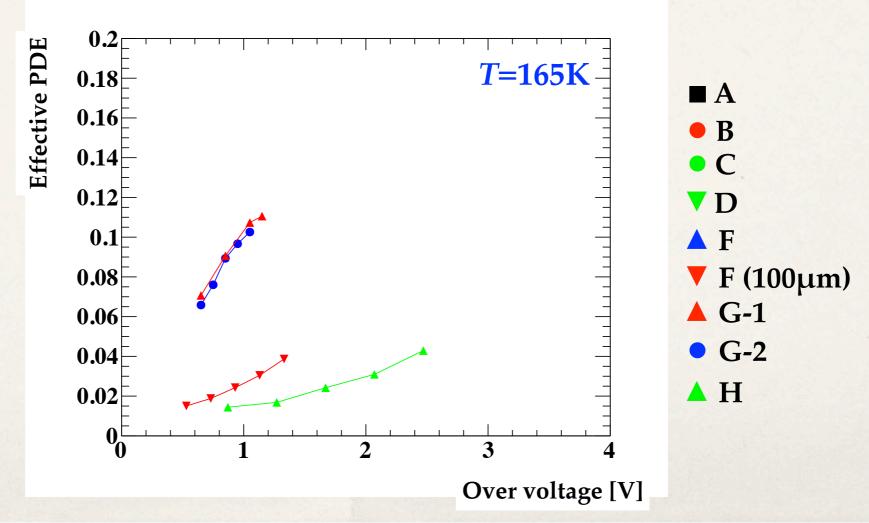
- Estimation of absolute PDE
  - \* PDE = (Observed # of p.e.) / (expected # of photons) for alpha event
- \* PDE includes effects of optical crosstalk and afterpulsing.



## PDE

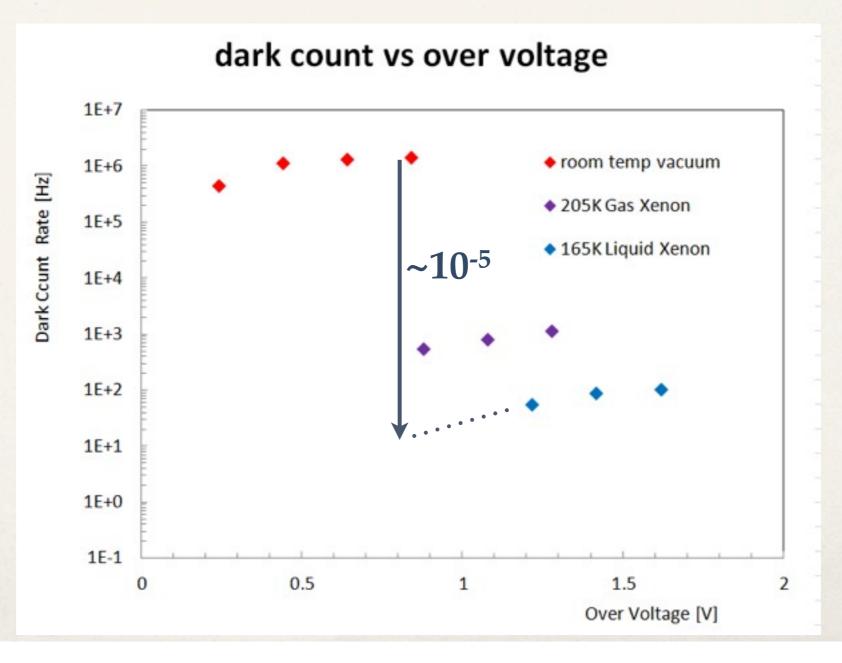
- \* Effective PDE after subtracting effect of optical crosstalk (5-20% prob.) and afterpulsing (10-30% prob.)
- \* Effective PDE ~10% achieved for best samples (type G)

\* Small contribution from NIR component of LXe scintillation (~1% level) included.



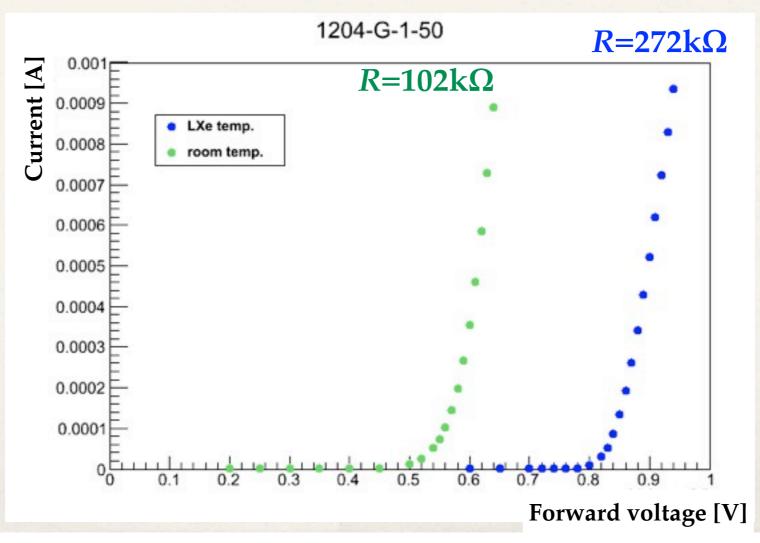
## Dark Count

 Dark count is highly suppressed at LXe temperature (165K) as expected (~10<sup>-5</sup>).



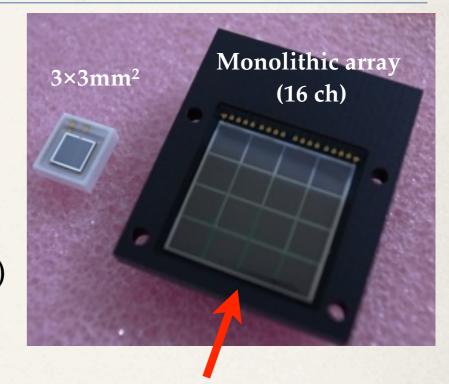
# Quench Resistor

- Resistance of quench resistor is measured by applying forward voltage.
- Quench resistor (poly silicon) shows ×2-3 higher resistivity at LXe temperature (165K).

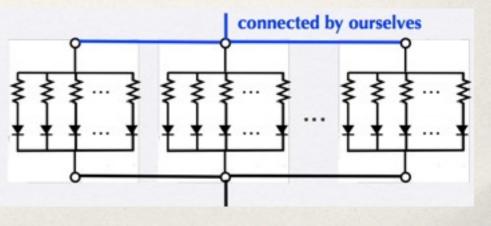


### Sensor Size

- \* Current largest MPPC (3×3mm²) is still too small for MEG LXe detector.
- \* Need at least ~10×10mm² to be a replacement of PMT.
- Possible issues for larger area sensor
  - Dark count rate (→ irrelevant at LXe temperature?)
  - Gain uniformity (→ single p.e. peak resolved?)
  - Large capacitance (→ long tail in waveform?, noise?)
- \* We tested properties of larger sensor by connecting 3×3 or 4×4 cells in commercial monolithic array in parallel.
  - \* Effective area: 9×9mm² for 3×3 cells connected
  - \* Effective area: 12×12mm² for 4×4 cells connected

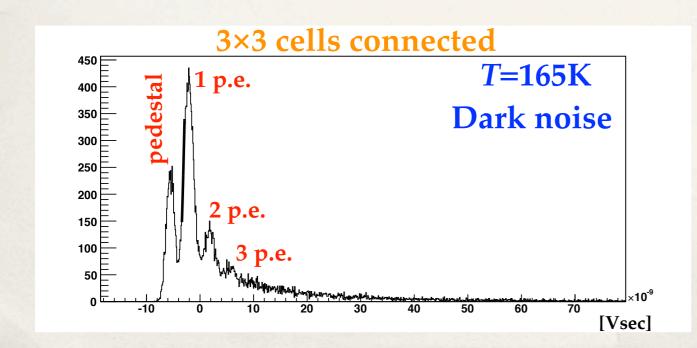


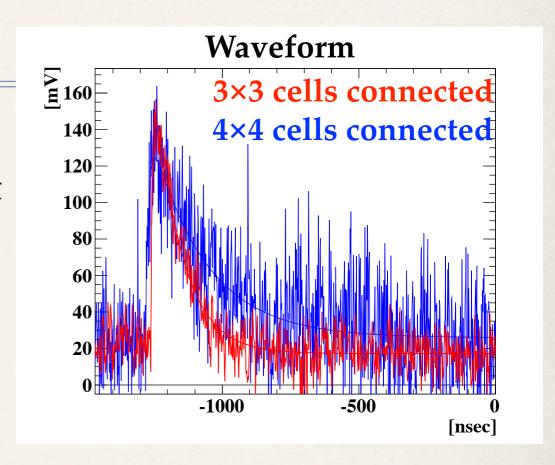
We need this size for single sensor!

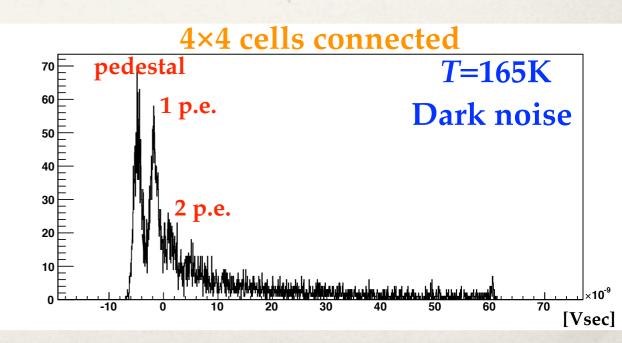


### Sensor Size

- Single p.e. peak resolved!
- Dark rate of 720Hz for 4×4 connection at LXe temp. → still low enough
- But there are some issues related to large sensor capacitance
  - Waveform with longer fall-time
  - Higher noise







### Other Issues

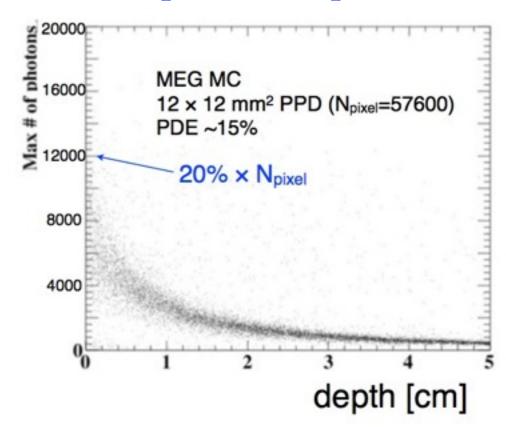
#### Dynamic range

- \* # of p.e. expected in MEG LXe detector
  - \* 12000p.e on  $12\times12$ mm² sensor area (20% of  $N_{\rm pixel}$ )
  - \* N.B.: time constant of scintillation emission of 45ns is comparable to cell recovery time.
- ◆ → OK. Non-linearity can anyway be corrected by a careful calibration.

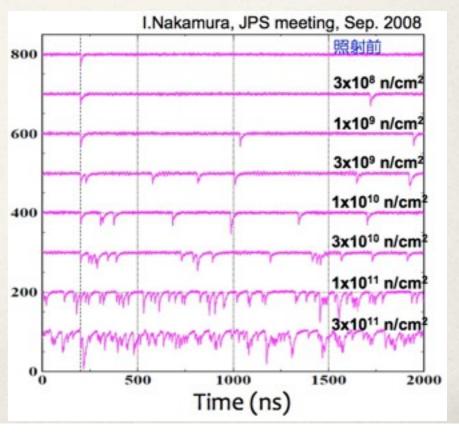
#### Radiation damage

- Irradiation foreseen at upgrade MEG
  - \* Neutron: <1.6×10<sup>8</sup> n/cm<sup>2</sup> for 5-years operation
  - \*  $\gamma$ : 0.6 Gy for 5-years operation
- $\bullet \to OK$ .

#### Expected # of p.e.



#### Effect of neutron irradiation



# Summary and Outlook

- \* MPPC sensitive to LXe scintillation photons is under development in collaboration with Hamamatsu for possible upgrade of MEG LXe  $\gamma$ -detector.
- \* Prototypes of UV-enhanced MPPC show promising performance (PDE of ~10% for best sample) although there are still some issues to be addressed.
- Next steps
  - Further improvement of performance
    - Improvement of PDE
    - Optimization of MPPC parameters such as pixel pitch and quench resistor
  - Production of large area prototype (~12×12mm²)
- \* We plan to build LXe detector prototype with 100ℓ-LXe and ~600 large area MPPCs by spring next year and to perform a beam test.
- We aim at the construction of the final detector with ~4000 MPPCs within next year.